<u>onsemi.</u>

MOSFET – N-Channel, SUPERFET[®] II

800 V, 58 A, 60 m Ω

FCH060N80

Description

SUPERFET II MOSFET is onsemi's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SUPERFET II MOSFET is very suitable for the switching power applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications.

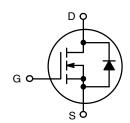
Features

- Typ. $R_{DS(on)} = 54 \text{ m}\Omega$
- 850 V @ $T_I = 150^{\circ}C$
- Ultra Low Gate Charge (Typ. Q_g = 270 nC)
- Low E_{OSS} (Typ. 23 µJ @ 400 V)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 981 pF)
- 100% Avalanche Tested
- This Device is RoHS Compliant

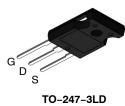
Applications

- AC-DC Power Supply
- LED Lighting

V _{DSS}	R _{DS(ON)} MAX	I _D MAX
800 V	$60~\mathrm{m}\Omega @ 10~\mathrm{V}$	58 A

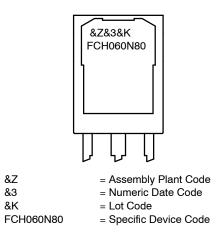


POWER MOSFET



CASE 340CH

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

Symbol	Para	meter	Value	Unit	
V _{DSS}	Drain to Source Voltage		800	V	
V _{GSS}	Gate to Source Voltage	DC	±20	V	
		AC (f > 1 Hz)	±30	1	
ID	Drain Current	Continuous (T _C = 25°C)	58	A	
		Continuous (T _C = 100°C)	36.8		
I _{DM}	Drain Current	Pulsed (Note 1)	174	A	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		2317	mJ	
I _{AS}	Avalanche Current (Note 1)		11.6	А	
E _{AR}	Repetitive Avalanche Energy (Note 1)		50	mJ	
dv/dt	MOSFET dv/dt		100	V/ns	
	Peak Diode Recovery dv/dt (Note 3)		20		
PD	Power Dissipation	(T _C = 25°C)	500	W	
		Derate Above 25°C	4	W/°C	
T _J , T _{STG}	Operating and Storage Temperature R	Operating and Storage Temperature Range		°C	
ΤL	Maximum Lead Temperature for Solder 1/8" from Case for 5 seconds	ring Purpose	300	°C	

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, Unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Repetitive rating: pulse width limited by maximum junction temperature. 2. $I_{AS} = 11.6 \text{ A}, V_{DD} = 50 \text{ V}, R_G = 25 \Omega$, starting $T_J = 25^{\circ}\text{C}$. 3. $I_{SD} \le 58 \text{ A}, \text{ di/dt} \le 200 \text{ A/}\mu\text{s}, V_{DD} \le \text{BV}_{DSS}$, starting $T_J = 25^{\circ}\text{C}$.

THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.25	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient, Max.	40	

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FCH060N80-F155	FCH060N80	TO-247-3LD	Tube	N/A	N/A	30 Units



ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit			
OFF CHARACT	OFF CHARACTERISTICS								
BV _{DSS}	Drain to Source Breakdown Voltage	V_{GS} = 0 V, I _D = 1 mA, T _J = 25°C	800			V			
$\Delta BV_{DSS} / \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 1$ mA, Referenced to $25^{\circ}C$		0.8		V/°C			
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 800 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			25	μΑ			
		$V_{DS} = 640 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$			250				
I _{GSS}	Gate to Body Leakage Current	V_{GS} = ±20 V, V_{DS} = 0 V			±100	nA			

ON CHARACTERISTICS

V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 5.8 \text{ mA}$	2.5		4.5	V
R _{DS(on)}	Static Drain to Source On Resistance	V_{GS} = 10 V, I _D = 29 A		54	60	mΩ
9FS	Forward Transconductance	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 29 \text{ A}$		68		S

DYNAMIC CHARACTERISTICS

C _{iss}	Input Capacitance	V_{DS} = 100 V, V_{GS} = 0 V, f = 1 MHz	11040	14685	pF
C _{oss}	Output Capacitance		298	395	pF
C _{rss}	Reverse Transfer Capacitance		10		pF
C _{oss}	Output Capacitance	V _{DS} = 480 V, V _{GS} = 0 V, f = 1MHz	147		pF
Coss(eff.)	Effective Output Capacitance	V_{DS} = 0 V to 480 V, V_{GS} = 0 V	981		pF
Q _{g(tot)}	Total Gate Charge at 10 V	$V_{DS} = 640 \text{ V}, \text{ I}_{D} = 58 \text{ A}, \text{ V}_{GS} = 10 \text{ V}$	270	350	nC
Q _{gs}	Gate to Source Gate Charge	(Note 4)	54		nC
Q _{gd}	Gate to Drain "Miller" Charge		100		nC
ESR	Equivalent Series Resistance	f = 1 MHz	0.78		Ω

SWITCHING CHARACTERISTICS

t _{d(on)}	Turn-On Delay Time	$V_{DD} = 400 \text{ V}, \text{ I}_{D} = 58 \text{ A}, \text{ V}_{GS} = 10 \text{ V}$	55	120	ns
t _r	Turn-On Rise Time	R _g = 4.7 Ω (Note 4)	73	156	ns
t _{d(off)}	Turn-Off Delay Time		213	436	ns
t _f	Turn-Off Fall Time		72	154	ns

SOURCE-DRAIN DIODE CHARACTERISTICS

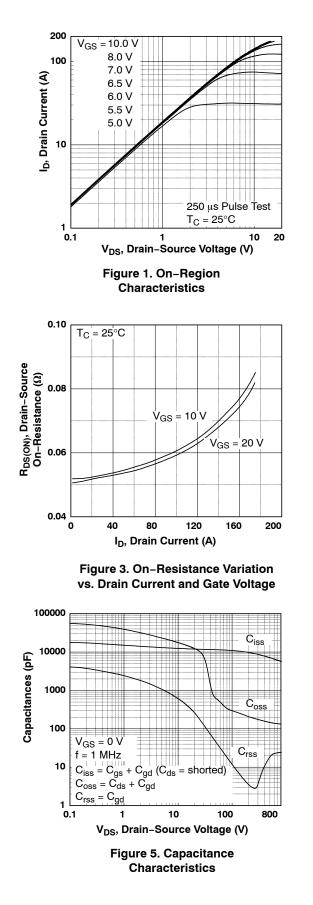
۱ _S	Maximum Continuous Drain to Source Diode Forward Current			58	А
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current			174	А
V _{SD}	Drain to Source Diode Forward Voltage	$V_{GS} = 0 V, I_{SD} = 58A$		1.2	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 V, I_{SD} = 58 A,$	850		ns
Q _{rr}	Reverse Recovery Charge	dl _F /dt = 100 Ă/μs	35		μC

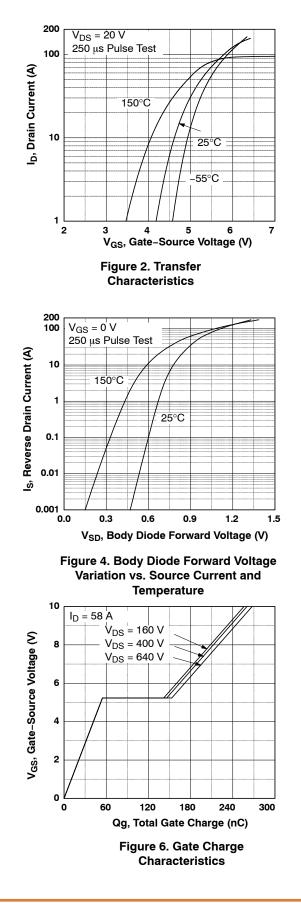
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Essentially independent of operating temperature typical characteristics.



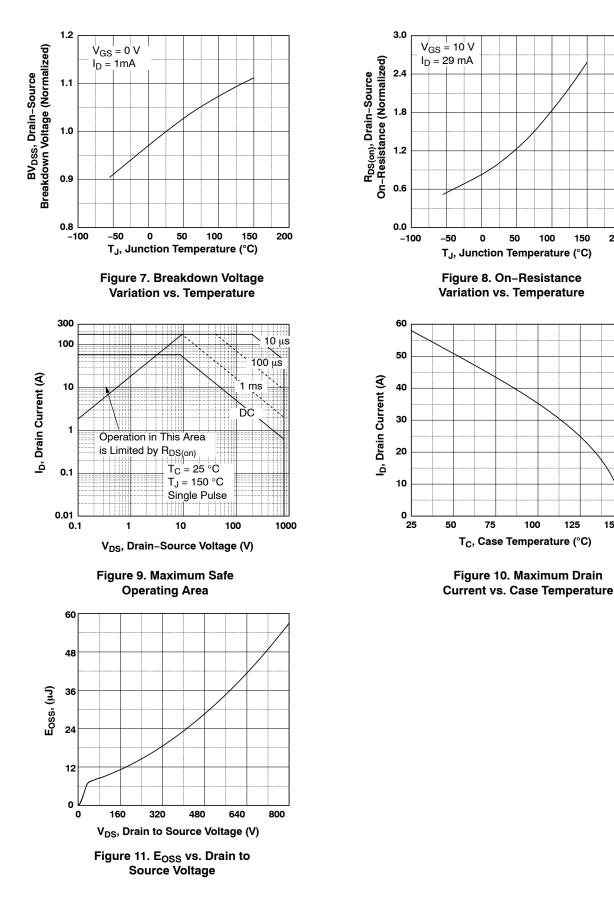
TYPICAL PERFORMANCE CHARACTERISTICS







TYPICAL PERFORMANCE CHARACTERISTICS (Continued)





150

125

150

200

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

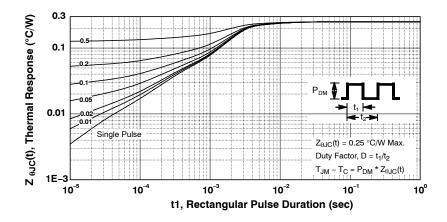
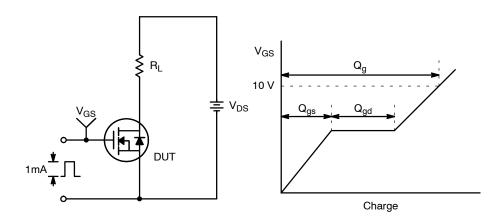


Figure 12. Transient Thermal Response Curve







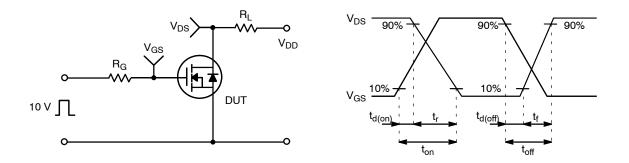


Figure 14. Resistive Switching Test Circuit & Waveforms

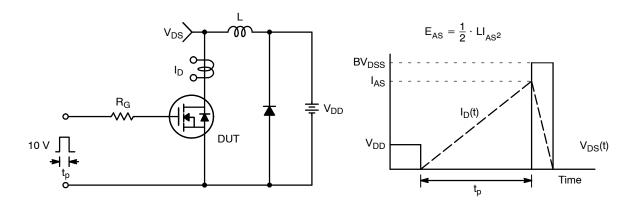


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms



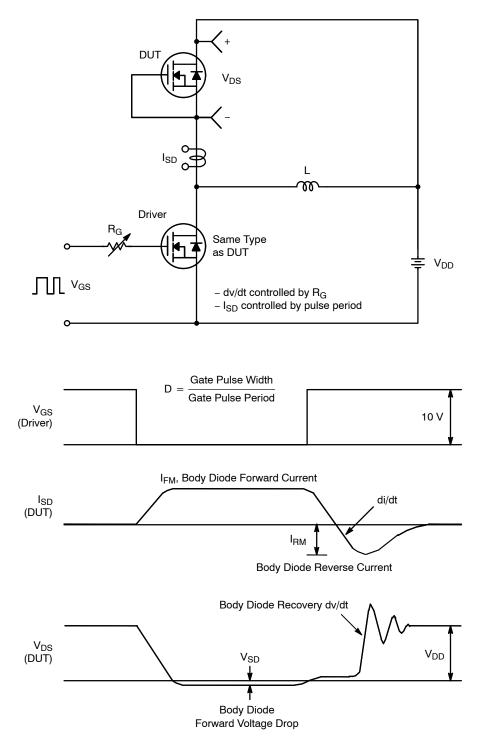


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

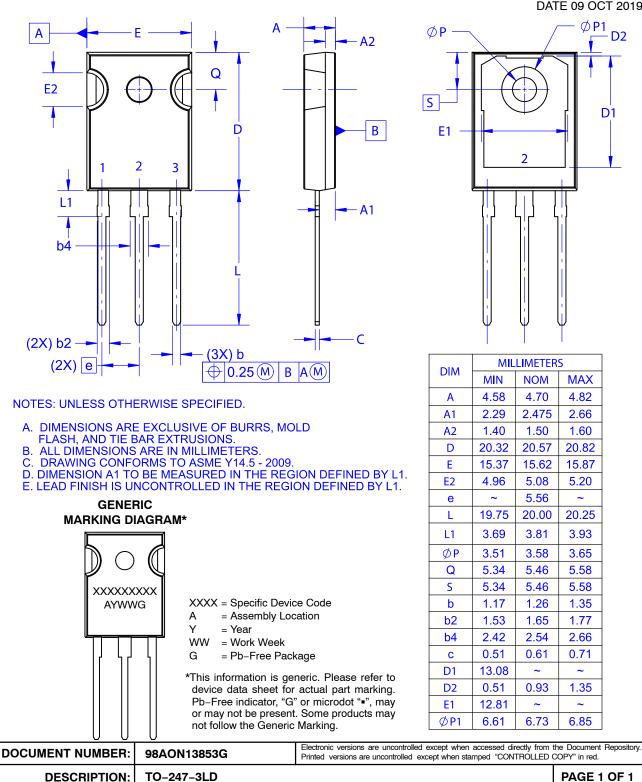
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